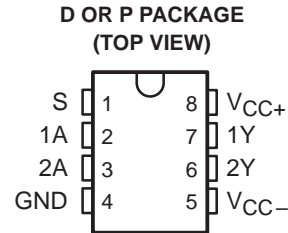


- Meets or Exceeds the Requirement of TIA/EIA-232-F and ITU Recommendation V.28
- Withstands Sustained Output Short Circuit to Any Low-Impedance Voltage Between –25 V and 25 V
- 2- $\mu$ s Maximum Transition Time Through the 3-V to –3-V Transition Region Under Full 2500-pF Load
- Inputs Compatible With Most TTL Families
- Common Strobe Input
- Inverting Output
- Slew Rate Can Be Controlled With an External Capacitor at the Output
- Standard Supply Voltages . . .  $\pm 12$  V

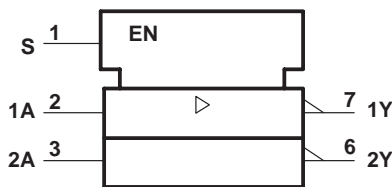


## description

The SN75150 is a monolithic dual line driver designed to satisfy the requirements of the standard interface between data-terminal equipment and data-communication equipment as defined by TIA/EIA-232-F. A rate of 20 kbits/s can be transmitted with a full 2500-pF load. Other applications are in data-transmission systems using relatively short single lines, in level translators, and for driving MOS devices. The logic input is compatible with most TTL families. Operation is from 12-V and –12-V power supplies.

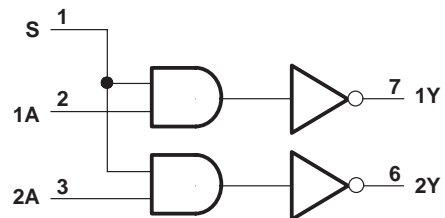
The SN75150 is characterized for operation from 0°C to 70°C.

## logic symbol†



† This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

## logic diagram (positive logic)



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PRODUCTION DATA information is current as of publication date. Products conform to specifications per the terms of Texas Instruments standard warranty. Production processing does not necessarily include testing of all parameters.

**TEXAS  
INSTRUMENTS**

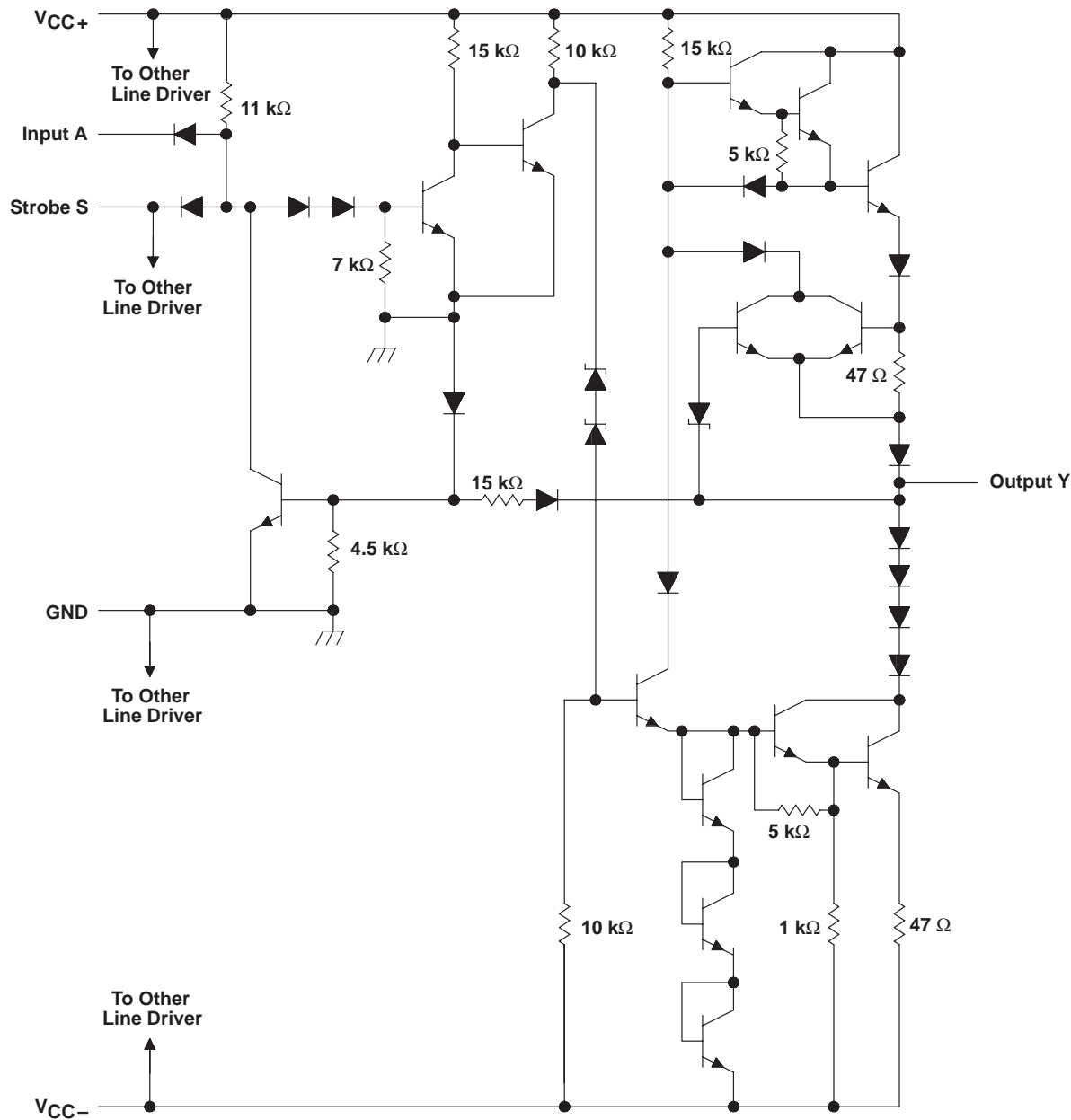
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# SN75150 DUAL LINE DRIVER

SLLS081C – JANUARY 1971 – REVISED JUNE 1999

## schematic (each line driver)



Resistor values shown are nominal.

**absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†**

Supply voltage, $V_{CC+}$ (see Note 1)	15 V
Supply voltage, $V_{CC-}$	–15 V
Input voltage, $V_I$	15 V
Applied output voltage	±25 V
Package thermal impedance, $\theta_{JA}$ (see Notes 2 and 3): D package	197°C/W
P package	104°C/W
Lead temperature 1,6 mm (1/16 inch) from case for 10 seconds	260°C
Storage temperature range, $T_{stg}$	–65°C to 150°C

† Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

- NOTES:
1. Voltage values are with respect to network ground terminal.
  2. Maximum power dissipation is a function of  $T_J(\max)$ ,  $\theta_{JA}$ , and  $T_A$ . The maximum allowable power dissipation at any allowable ambient temperature is  $P_D = (T_J(\max) - T_A)/\theta_{JA}$ . Operating at the absolute maximum  $T_J$  of 150°C can impact reliability.
  3. The package thermal impedance is calculated in accordance with JESD 51, except for through-hole packages, which use a trace length of zero.

**recommended operating conditions**

		MIN	NOM	MAX	UNIT
Supply voltage	$V_{CC+}$	10.8	12	13.2	V
	$V_{CC-}$	–10.8	–12	–13.2	
High-level input voltage, $V_{IH}$		2		5.5	V
Low-level input voltage, $V_{IL}$		0		0.8	V
Driver output voltage, $V_O$				±15	V
Operating free-air temperature, $T_A$		0		70	°C

# SN75150

## DUAL LINE DRIVER

SLLS081C – JANUARY 1971 – REVISED JUNE 1999

**electrical characteristics over recommended operating free-air temperature range,  $V_{CC\pm} = \pm 13.2$  V (unless otherwise noted)**

PARAMETER		TEST CONDITIONS	MIN	TYP†	MAX	UNIT
$V_{OH}$	High-level output voltage	$V_{CC+} = 10.8$ V, $V_{IL} = 0.8$ V, $V_{CC-} = -10.8$ V, $R_L = 3$ k $\Omega$ to 7 k $\Omega$	5	8		V
$V_{OL}$	Low-level output voltage (see Note 4)	$V_{CC+} = 10.8$ V, $V_{IH} = 2$ V, $V_{CC-} = -10.8$ V, $R_L = 3$ k $\Omega$ to 7 k $\Omega$		-8	-5	V
$I_{IH}$	High-level input current	Data input Strobe input $V_I = 2.4$ V		1	10	$\mu$ A
				2	20	
$I_{IL}$	Low-level input current	Data input Strobe input $V_I = 0.4$ V		-1	-1.6	mA
				-2	-3.2	
$I_{OS}$	Short-circuit output current‡	$V_O = 25$ V		2	8	mA
		$V_O = -25$ V		-3	-8	
		$V_O = 0$ , $V_I = 3$ V	10	15	30	
		$V_O = 0$ , $V_I = 0$	-10	-15	-30	
$I_{CCH+}$	Supply current from $V_{CC+}$ , high-level output	$V_I = 0$ , $R_L = 3$ k $\Omega$ , $T_A = 25^\circ$ C		10	22	mA
$I_{CCH-}$	Supply current from $V_{CC-}$ , high-level output			-1	-10	mA
$I_{CCL+}$	Supply current from $V_{CC+}$ , low-level output	$V_I = 3$ V, $R_L = 3$ k $\Omega$ , $T_A = 25^\circ$ C		8	17	mA
$I_{CCL-}$	Supply current from $V_{CC-}$ , low-level output			-9	-20	mA

† All typical values are at  $V_{CC+} = 12$  V,  $V_{CC-} = -12$  V,  $T_A = 25^\circ$ C.

‡ Not more than one output should be shorted at a time.

NOTE 4: The algebraic convention, in which the less positive (more negative) limit is designated as minimum, is used in this data sheet for logic levels only, e.g., when -5 V is the maximum, the typical value is a more negative voltage.

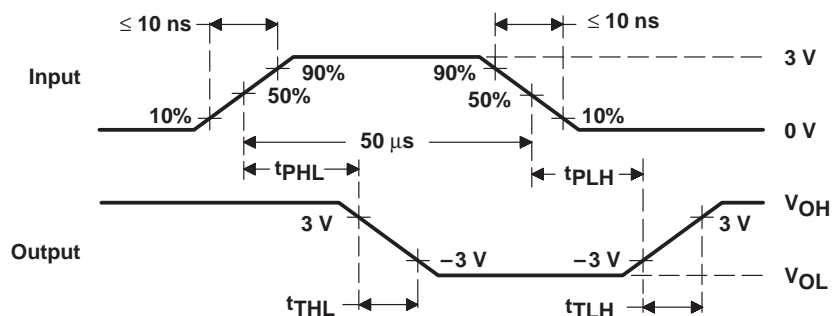
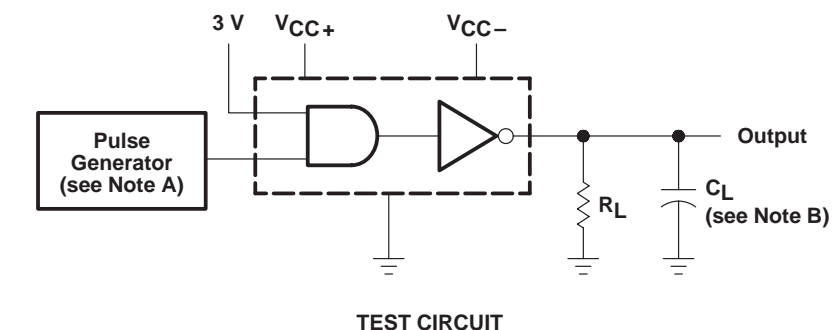
**switching characteristics,  $V_{CC+} = 12$  V,  $V_{CC-} = -12$  V,  $T_A = 25^\circ$ C (see Figure 1)**

PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
$t_{TLH}$	Transition time, low-to-high-level output	$C_L = 2500$ pF, $R_L = 3$ k $\Omega$ to 7 k $\Omega$	0.2	1.4	2	$\mu$ s
$t_{THL}$	Transition time, high-to-low-level output		0.2	1.5	2	$\mu$ s
$t_{TLH}$	Transition time, low-to-high-level output	$C_L = 15$ pF, $R_L = 7$ k $\Omega$		40		ns
$t_{THL}$	Transition time, high-to-low-level output			20		ns
$t_{PLH}$	Propagation delay time, low-to-high-level output	$C_L = 15$ pF, $R_L = 7$ k $\Omega$		60		ns
$t_{PHL}$	Propagation delay time, high-to-low-level output			45		ns



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## PARAMETER MEASUREMENT INFORMATION



- NOTES: A. The pulse generator has the following characteristics: duty cycle  $\leq 50\%$ ,  $Z_O \approx 50 \Omega$ .  
B.  $C_L$  includes probe and jig capacitance.

Figure 1. Test Circuit and Voltage Waveforms

TYPICAL CHARACTERISTICS

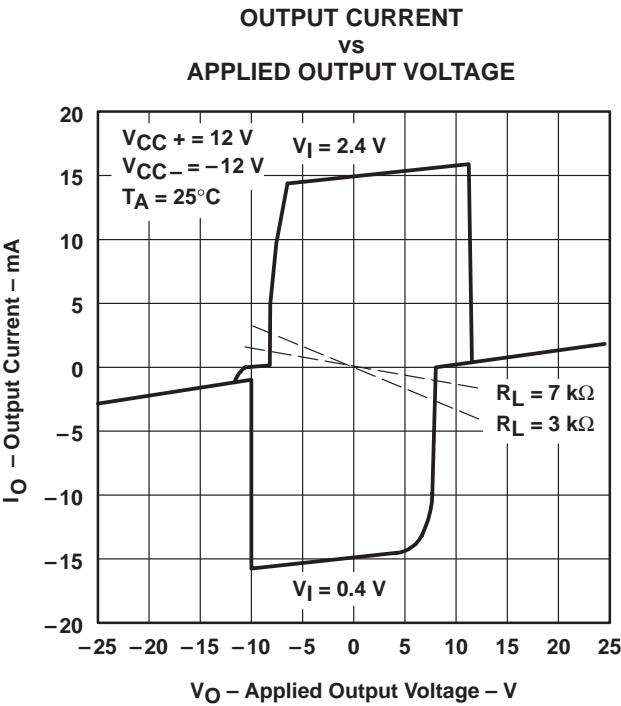


Figure 2

## PACKAGING INFORMATION

Orderable part number	Status (1)	Material type (2)	Package   Pins	Package qty   Carrier	RoHS (3)	Lead finish/ Ball material (4)	MSL rating/ Peak reflow (5)	Op temp (°C)	Part marking (6)
<a href="#">SN75150D</a>	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75150
SN75150D.A	Active	Production	SOIC (D)   8	75   TUBE	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75150
<a href="#">SN75150DR</a>	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75150
SN75150DR.A	Active	Production	SOIC (D)   8	2500   LARGE T&R	Yes	NIPDAU	Level-1-260C-UNLIM	0 to 70	75150
<a href="#">SN75150P</a>	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75150P
SN75150P.A	Active	Production	PDIP (P)   8	50   TUBE	Yes	NIPDAU	N/A for Pkg Type	0 to 70	SN75150P

<sup>(1)</sup> **Status:** For more details on status, see our [product life cycle](#).

<sup>(2)</sup> **Material type:** When designated, preproduction parts are prototypes/experimental devices, and are not yet approved or released for full production. Testing and final process, including without limitation quality assurance, reliability performance testing, and/or process qualification, may not yet be complete, and this item is subject to further changes or possible discontinuation. If available for ordering, purchases will be subject to an additional waiver at checkout, and are intended for early internal evaluation purposes only. These items are sold without warranties of any kind.

<sup>(3)</sup> **RoHS values:** Yes, No, RoHS Exempt. See the [TI RoHS Statement](#) for additional information and value definition.

<sup>(4)</sup> **Lead finish/Ball material:** Parts may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

<sup>(5)</sup> **MSL rating/Peak reflow:** The moisture sensitivity level ratings and peak solder (reflow) temperatures. In the event that a part has multiple moisture sensitivity ratings, only the lowest level per JEDEC standards is shown. Refer to the shipping label for the actual reflow temperature that will be used to mount the part to the printed circuit board.

<sup>(6)</sup> **Part marking:** There may be an additional marking, which relates to the logo, the lot trace code information, or the environmental category of the part.

Multiple part markings will be inside parentheses. Only one part marking contained in parentheses and separated by a "~" will appear on a part. If a line is indented then it is a continuation of the previous line and the two combined represent the entire part marking for that device.

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## TAPE AND REEL INFORMATION



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN75150DR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

## TAPE AND REEL BOX DIMENSIONS



\*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN75150DR	SOIC	D	8	2500	340.5	336.1	25.0

## TUBE



\*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (μm)	B (mm)
SN75150D	D	SOIC	8	75	507	8	3940	4.32
SN75150D.A	D	SOIC	8	75	507	8	3940	4.32
SN75150P	P	PDIP	8	50	506	13.97	11230	4.32
SN75150P.A	P	PDIP	8	50	506	13.97	11230	4.32

P (R-PDIP-T8)

PLASTIC DUAL-IN-LINE PACKAGE



- NOTES:
- A. All linear dimensions are in inches (millimeters).
  - B. This drawing is subject to change without notice.
  - C. Falls within JEDEC MS-001 variation BA.



**D0008A**

# PACKAGE OUTLINE

**SOIC - 1.75 mm max height**

SMALL OUTLINE INTEGRATED CIRCUIT



4214825/C 02/2019

## NOTES:

1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
4. This dimension does not include interlead flash.
5. Reference JEDEC registration MS-012, variation AA.

# EXAMPLE BOARD LAYOUT

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



LAND PATTERN EXAMPLE  
EXPOSED METAL SHOWN  
SCALE:8X



SOLDER MASK DETAILS

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NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.

## EXAMPLE STENCIL DESIGN

D0008A

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



SOLDER PASTE EXAMPLE  
BASED ON .005 INCH [0.125 MM] THICK STENCIL  
SCALE:8X

4214825/C 02/2019

NOTES: (continued)

8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
9. Board assembly site may have different recommendations for stencil design.

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